

SANYO Semiconductors DATA SHEET

2SD2721 — NPN Triple Diffused Planar Silicon Transistor Driver Applications

Features

- · Large current capacitance.
- · Wide ASO and high durability against breakdown.
- · Adoption of MBIT process.
- · Attachment workability is good by Mica-less package.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Collector-to-Base Voltage	VCBO		160	V
Collector-to-Emitter Voltage	VCEO		120	V
Emitter-to-Base Voltage	VEBO		6	V
Collector Current	IC		12	А
Collector Current (Pulse)	ICP		20	А
Collector Dissipation	Do.		3.0	W
	PC	Tc=25°C	75	W
Junction Temperature	Tj		150	°C
Storage Temperature	Tstg		-55 to +150	°C

Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
	Symbol		min	typ	max	Offic
Collector Cutoff Current	ICBO	V _{CB} =160V, I _E =0A			0.1	mA
Emitter Cutoff Current	IEBO	VEB=4V, IC=0A			0.1	mA
DC Current Gain	hFE1	V _{CE} =5V, I _C =1A	100		200	
	hFE2	V _{CE} =5V, I _C =5A	35			
Gain-Bandwidth Product	fŢ	VCE=5V, IC=1A		15		MHz
Output Capacitance	Cob	V _{CB} =10V, f=1MHz		140		pF

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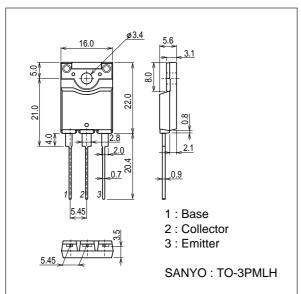
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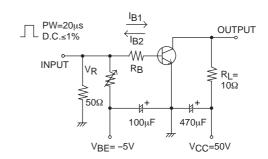
Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Offic
Base-to-Emitterr Voltage	VBE	VCE=5V, IC=5A			1.5	V
Collector-to-Emitter Saturation Voltage	V _{CE} (sat)	I _C =5A, I _B =0.5A		0.2	2.0	V
Collector-to-Base Breakdown Voltage	V(BR)CBO	IC=5mA, IE=0A	160			V
Collector-to-Emitter Breakdown Voltage	V(BR)CEO	IC=50mA, RBE=∞	120			V
Emitter-to-Base Breakdown Voltage	V(BR)EBO	I _E =5mA, I _C =0A	6			V
Turn-On Time	ton	See specified Test Circuit.		0.56		μS
Storage Time	tstg	See specified Test Circuit.		3.3		μS
Fall Time	t _f	See specified Test Circuit.		0.4		μS

Package Dimensions

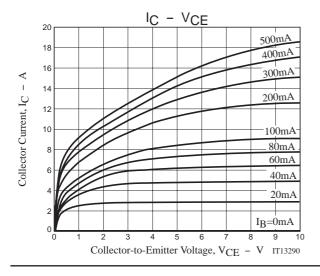
unit : mm (typ) 7504-001

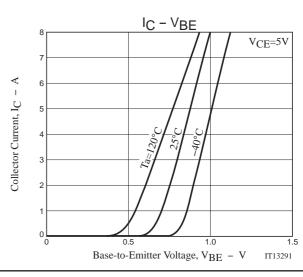


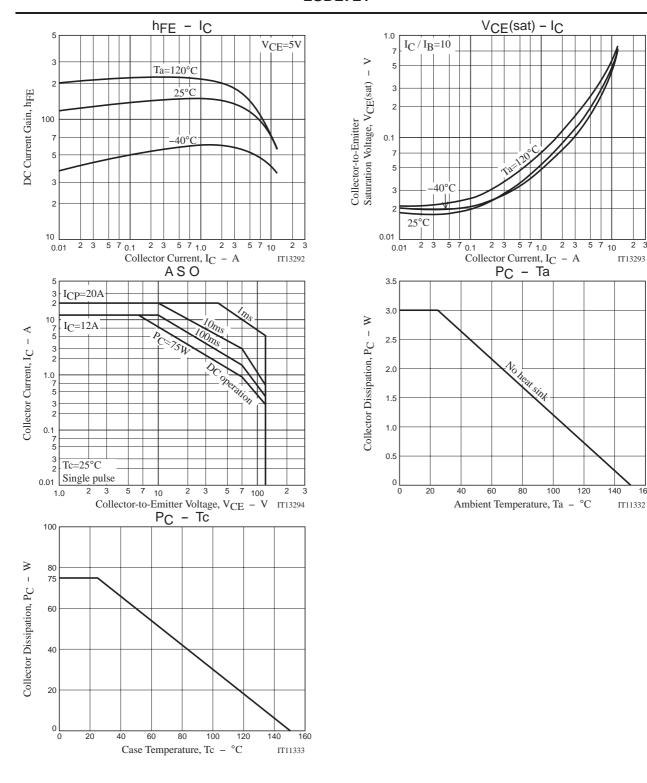
Switching Time Test Circuit



$$I_{C}=10I_{B1}=-10I_{B2}=5A$$







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